

Preface

2013 2nd International Conference on Advanced Materials and its Application(AMA2013) is a conference focusing its center on Advanced Materials and its Application. The objective of the conference is to provide a forum for different researchers in different fields especially in Material field to exchange their different findings. The researchers are from different countries and in different professionals. The conference will bring all the researchers from all around the world together to share their new findings, thus to promote academic exchanging.

All the papers accepted had been passed the strict peer-review course before their publication by TTP. Here, we should show our sincere thanks to all authors for their high-quality papers and their careful presentations in the conference. At the same time, all reviewers should be thanked too for their careful work. In addition, all sponsors and all team members of TTP should be especially thanked too for their hard work and careful edition on AMA2013.

It's the joint efforts of all different parts that they makes our conference be successful.

The Organizing Committee of AMA2013

Committees:

Honorary chair:

S.L. Xue, Maryland University of America

Fitch Chen, Zhongshan University

Organizing Chairs:

X.H Zhan, Nanjing university of Aeronautics

David Yang, Wuhan University of Technology

Organizing Committee:

Z.P. Lv, Huazhong university of science and technology

Q. Huang, Huazhong university of science and technology

Helen Li, Yangtze university

Sara He, Wuhan textile university

Jack Ma, Wuhan textile university

George Liu, Huaxia college Wuhan Polytechnic University

Hanley Wang, Wuchang University of Technology

Diana Yu, Huazhong university of science and technology

Anna Tian, Wuchang University of Technology

Fitch Chen, Zhongshan University

David Bai, Nanjing university of technology

Y. Li, South China normal university

Harry Song, Guangzhou Univeristy

Sponsors:

Wuhan institute of technology, China

Beijing Material Research Center, China

International Material Research Society, Hong Kong